



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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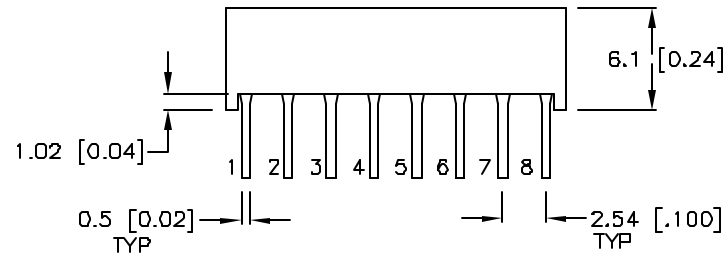
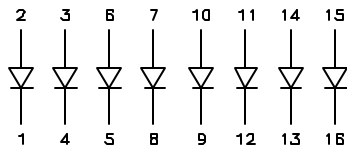
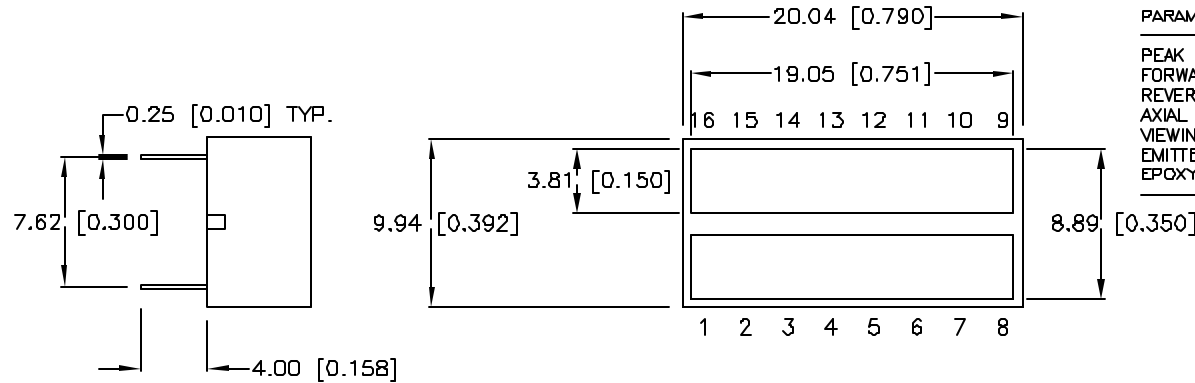
DATE	REVISIONS	REV
4-8-96	E.C.N.# 10144./	A

DRAWING NUMBER	REV
SSB-LXF100SRW	A

UNCONTROLLED DOCUMENT

ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		660 (RED)		nm	
FORWARD VOLTAGE		1.7	2.2	V_f	
REVERSE VOLTAGE	5.0			V_r	$I_f=100\mu\text{A}$
AXIAL INTENSITY		80		mcd	$I_f=20\text{mA}$
VIEWING ANGLE		160		2x theta	
EMITTED COLOR		RED			
EPOXY LENS FINISH		MILKY WHITE DIFFUSED			



LIMITS OF SAFE OPERATION PER CHIP AT 25°C

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	100	mW
DERATE FROM 25°C	-0.5	mW/°C
OPERATING, STORAGE TEMP	-40 TO +85	°C
LEAD SOLDERING TEMP	+230	°C
2.0mm FROM BODY		3 SEC. MAX

* $t < 10\mu\text{s}$

UNIT: mm [INCHES]
TOLERANCE: ± 0.25 [± 0.01] UNLESS OTHERWISE SPECIFIED

RELIABILITY NOTE
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

UNCONTROLLED DOCUMENT

LUMEX OPTO COMPONENTS INC.		292 E. HELLEN ROAD PALATINE, ILLINOIS 60067 (708) 359-2790	
<small>CONFIDENTIAL INFORMATION THE INFORMATION CONTAINED IN THIS DOCUMENT IS THE PROPERTY OF LUMEX OPTO/COMPONENTS, INC. EXCEPT AS SPECIFICALLY AUTHORIZED IN WRITING BY LUMEX OPTO/COMPONENTS, INC., THE HOLDER OF THIS DOCUMENT SHALL KEEP ALL INFORMATION CONTAINED HEREIN CONFIDENTIAL AND SHALL PROTECT SAME IN WHOLE OR IN PART FROM DISCLOSURE AND DISSEMINATION TO ALL THIRD PARTIES.</small>			
DATE: 3-15-96	DWN:	CHK'D:	APPD:
SCALE: N/A			
19.05mm x 8.89mm 2 WINDOW, LIGHT BAR, RED, MILKY WHITE DIFFUSED			
PAGE 1 OF 1	DRAWING NUMBER SSB-LXF100SRW		REV A

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